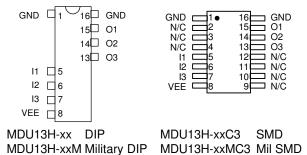
# TRIPLE, ECL-INTERFACED FIXED DELAY LINE (SERIES MDU13H)



#### **FEATURES**

- Three independent delay lines
- Fits standard 16-pin DIP socket
- Auto-insertable
- Input & outputs fully 10KH-ECL interfaced & buffered

## **PACKAGES**



## **FUNCTIONAL DESCRIPTION**

The MDU13H-series device is a 3-in-1 digitally buffered delay line. The signal inputs (I1-I3) are reproduced at the outputs (O1-O3), shifted in time by an amount determined by the device dash number (See Table). The delay lines function completely independently of each other.

#### PIN DESCRIPTIONS

I1-I3 Signal Inputs
O1-O3 Signal Outputs
VEE -5 Volts
GND Ground

## **SERIES SPECIFICATIONS**

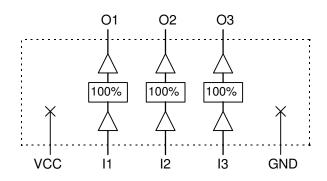
Minimum input pulse width: 50% of total delay

Output rise time: 2ns typical
 Supply voltage: -5VDC ± 5%

Power dissipation: 200mw typical (no load)
 Operating temperature: -30° to 85° C

o operating temperature. 50 to 55 o

Temp. coefficient of total delay: 100 PPM/°C



Functional block diagram

## DASH NUMBER SPECIFICATIONS

Part	Delay Per
Number	Line (ns)
MDU13H-3	3 ± 1.0
MDU13H-4	4 ± 1.0
MDU13H-5	5 ± 1.0
MDU13H-10	10 ± 1.0
MDU13H-15	15 ± 1.0
MDU13H-20	20 ± 1.0
MDU13H-25	$25 \pm 2.0$
MDU13H-30	$30 \pm 2.0$
MDU13H-35	$35 \pm 2.0$
MDU13H-40	$40 \pm 2.0$
MDU13H-45	45 ± 2.2
MDU13H-50	50 ± 2.5
<u> </u>	<u> </u>

<sup>\*</sup> Total delay is referenced to first tap output Input to first tap = 1.5ns  $\pm 1$ ns

NOTE: Any dash number between 3 and 50 not shown is also available.

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# **APPLICATION NOTES**

## HIGH FREQUENCY RESPONSE

The MDU13H tolerances are guaranteed for input pulse widths and periods greater than those specified in the test conditions. Although the device will function properly for pulse widths as small as 50% of the total delay and periods as small as 100% of the total delay (for a symmetric input), the delays may deviate from their values at low frequency. However, for a given input condition, the deviation will be repeatable from pulse to pulse. Contact technical support at Data Delay Devices if your application requires device testing at a specific input condition.

#### POWER SUPPLY BYPASSING

The MDU13H relies on a stable power supply to produce repeatable delays within the stated tolerances. A 0.1uf capacitor from VEE to GND, located as close as possible to the VEE pin, is recommended. A wide VEE trace and a clean ground plane should be used.

## **DEVICE SPECIFICATIONS**

TABLE 1: ABSOLUTE MAXIMUM RATINGS

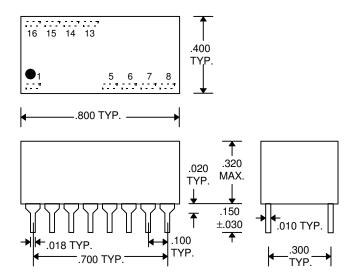
PARAMETER	SYMBOL	MIN	MAX	UNITS	NOTES
DC Supply Voltage	$V_{EE}$	-7.0	0.3	<b>V</b>	
Input Pin Voltage	$V_{IN}$	V <sub>EE</sub> - 0.3	0.3	V	
Storage Temperature	$T_{STRG}$	-55	150	С	
Lead Temperature	$T_{LEAD}$		300	С	10 sec

**TABLE 2: DC ELECTRICAL CHARACTERISTICS** 

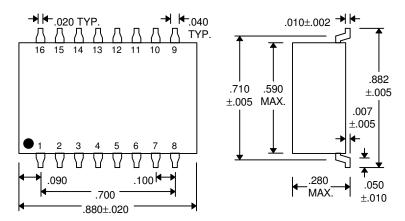
(0C to 75C)

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
High Level Output Voltage	V <sub>OH</sub>	-1.020		-0.735	V	$V_{IH} = MAX,50\Omega$ to -2V
Low Level Output Voltage	$V_{OL}$	-1.950		-1.600	V	$V_{IL} = MIN, 50\Omega$ to -2V
High Level Input Voltage	$V_{IH}$			-1.070	V	
Low Level Input Voltage	$V_{IL}$	-1.480			V	
High Level Input Current	I <sub>IH</sub>			475	μΑ	$V_{IH} = MAX$
Low Level Input Current	I <sub>IL</sub>	0.5			μΑ	$V_{IL} = MIN$

# **PACKAGE DIMENSIONS**



MDU13H-xx (Commercial DIP) MDU13H-xxM (Military DIP)



MDU13H-xxC3 (Commercial SMD) MDU13H-xxMC3 (Military SMD)

# **DELAY LINE AUTOMATED TESTING**

### **TEST CONDITIONS**

INPUT: OUTPUT:

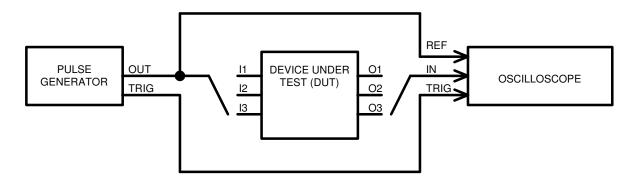
Source Impedance:  $50\Omega$  Max.

Rise/Fall Time: 2.0 ns Max. (measured

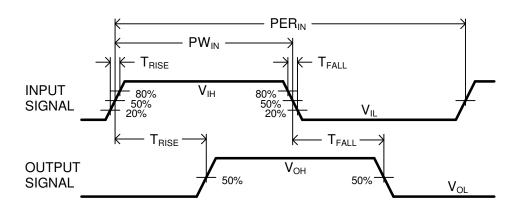
between 20% and 80%)
PW<sub>IN</sub> = 1.5 x Total Delay

Pulse Width:  $PW_{IN} = 1.5 \times Total Delay$ Period:  $PER_{IN} = 10 \times Total Delay$ 

NOTE: The above conditions are for test only and do not in any way restrict the operation of the device.



**Test Setup** 



**Timing Diagram For Testing**